

Description

The TDL501 series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon high speed photo transistor in a plastic LSOP6 package.

With the robust coplanar double mold structure, TDL501 series provide the most stable isolation feature.

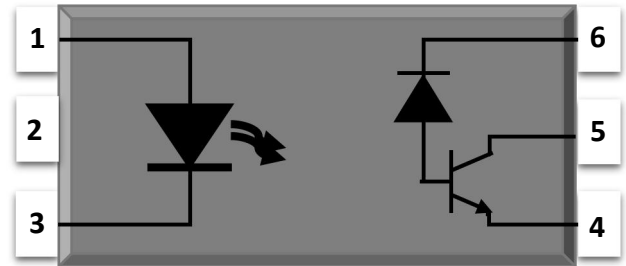
Features

- High isolation 5000 VRMS
- DC input with high speed transistor
- Operating temperature range - 40 °C to 100 °C
- REACH compliance
- Halogen free
- MSL class 1
- Regulatory Approvals
 - UL - UL1577
 - VDE - EN60747-5-5(VDE0884-5)
 - CQC - GB4943.1, GB8898
 - cUL- CSA Component Acceptance Service Notice No. 5A

Applications

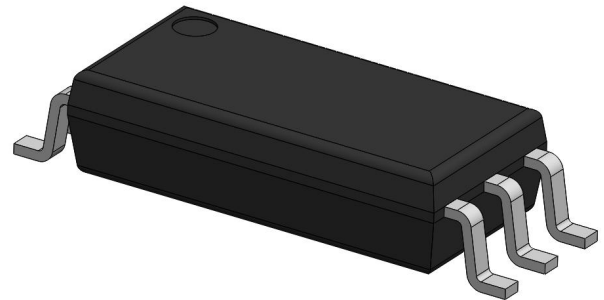
- Line receivers
- Telecommunication equipment
- Out interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling
- Pulse transformer replacement
- Computer-peripheral interface

SCHEMATIC



PIN DEFINITION

| | |
|-------------------------|--------------|
| 1. Anode | 6.VCC |
| 2. No Connection | 5.VO |
| 3. Cathode | 4.GND |





ABSOLUTE MAXIMUM RATINGS

| PARAMETER | SYMBOL | VALUE | UNIT | Note |
|--------------------------|----------------|---------|------|------|
| INPUT | | | | |
| Forward Current | I_F | 25 | mA | |
| Peak Forward Current | I_{FP} | 50 | mA | 1 |
| Peak Transient Current | $I_{F(trans)}$ | 1 | A | 2 |
| Reverse Voltage | V_R | 5 | V | |
| Input Power Dissipation | P_I | 100 | mW | |
| OUTPUT | | | | |
| Supply Voltage | V_{CC} | -0.5~30 | V | |
| Output Voltage | V_O | -0.5~20 | V | |
| Output Current | I_o | 8 | mA | |
| Peak Output Current | I_o | 16 | mA | |
| Output Power Dissipation | P_O | 100 | mW | |
| COMMON | | | | |
| Total Power Dissipation | P_{tot} | 200 | mW | |
| Isolation Voltage | V_{iso} | 500 | Vrms | 3 |
| Operating Temperature | T_{opr} | -40~100 | °C | |
| Storage Temperature | T_{stg} | -55~125 | °C | |
| Soldering Temperature | T_{sol} | 260 | °C | 4 |

Note 1. 50% duty, 1ms P.W

Note 2. $\leq 1\mu s$ P.W, 300pps

Note 3. AC For 1 Minute, R.H. = 40 ~ 60%

Note 4. For 10 seconds



| ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C | | | | | | | |
|---|------------------|------------------|------------------|-----|------|--|------|
| PARAMETER | SYMBOL | MIN | TYP | MAX | UNIT | TEST CONDITION | NOTE |
| INPUT | | | | | | | |
| Forward Voltage | V _F | - | 1.35 | 1.8 | V | I _F =16mA | |
| Reverse Current | I _R | - | - | 10 | μA | V _R =5V | |
| Input Capacitance | C _{in} | - | 60 | - | pF | V=0, f=1MHz | |
| OUTPUT | | | | | | | |
| High Level Supply Current | I _{CCH} | - | 0.08 | 1 | μA | I _F =0mA, V _O =Open, V _{CC} =30V, Ta=25°C | |
| Low Level Supply Current | I _{CCL} | - | 600 | - | μA | I _F =16mA, V _O =Open, V _{CC} =30V | |
| Logic High Output Current | I _{OH} | - | 0.001 | 0.5 | μA | I _F =0mA, V _O =V _{CC} =5.5V, Ta=25°C | |
| | | - | 0.01 | 1 | μA | I _F =0mA, V _O =V _{CC} =15V, Ta=25°C | |
| | | - | - | 50 | μA | I _F =0mA, V _O =V _{CC} =15V | |
| TRANSFER CHARACTERISTICS(at Ta=0 to 70°C , unless specified otherwise) | | | | | | | |
| Current Transfer Ratio | CTR | 20 | 60 | 100 | % | I _F = 16mA ,V _O = 0.4V, V _{CC} =4.5V, Ta=25°C | |
| | | 15 | - | - | | I _F = 16mA ,V _O = 0.5V, V _{CC} =4.5V | |
| Logic Low Output Voltage | V _{OL} | - | 0.08 | 0.4 | V | I _F = 16mA ,I _O = 3mA, V _{CC} =4.5V, Ta=25°C | |
| | | - | - | 0.5 | | I _F = 16mA ,I _O = 2.4mA, V _{CC} =4.5V | |
| Isolation Resistance | R _{iso} | 10 ¹² | 10 ¹⁴ | - | Ω | DC500V, 40 ~ 60% R.H. | |
| Floating Capacitance | C _{IO} | - | 0.3 | - | pF | V=0, f=1MHz | |



ELECTRICAL OPTICAL CHARACTERISTICS

| PARAMETER | SYMBOL | MIN | TYP | MAX | UNIT | TEST CONDITION | NOTE |
|---|-----------------|-----|------|-----|-------|--|--------|
| SWITCHING CHARACTERISTICS(at Ta=0 to 70°C, I _F =16mA, V _{CC} =5V, unless specified otherwise) | | | | | | | |
| Propagation Delay Time to Logic Low | TPHL | - | 0.4 | 0.8 | μs | R _L =1.9kΩ, T _A =25°C | Fig.13 |
| | | - | - | 1.0 | | R _L =1.9kΩ | |
| Propagation Delay Time to Logic High | TPLH | - | 0.35 | 0.8 | μs | R _L =1.9kΩ, T _A =25°C | Fig.13 |
| | | - | - | 1.0 | | R _L =1.9kΩ | |
| Common Mode Transient Immunity at Logic High | CM _H | 15 | - | - | kV/μs | I _F = 0mA, V _{CM} =1500Vpp, R _L =1.9kΩ, T _A =25°C | Fig.15 |
| Common Mode Transient Immunity at Logic Low | CM _L | 15 | - | - | kV/μs | I _F = 16mA, V _{CM} =1500Vpp, R _L =1.9kΩ, T _A =25°C | Fig.15 |

CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Forward Voltage

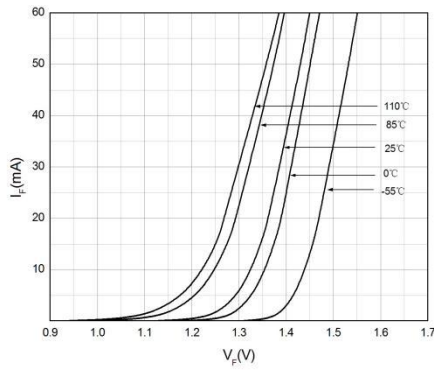


Fig.2 Forward Voltage vs. Ambient Temperature

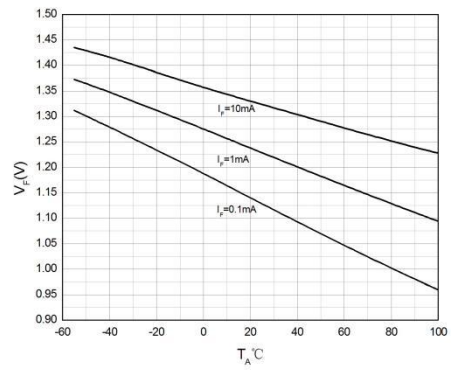


Fig.3 Normalized CTR vs. Forward Current

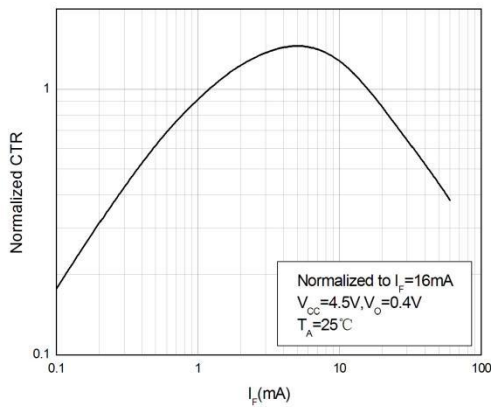


Fig.4 Normalized CTR vs. Ambient Temperature

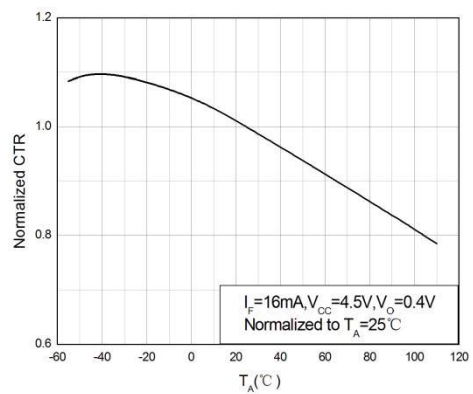


Fig.5 Output Current vs. Output Voltage

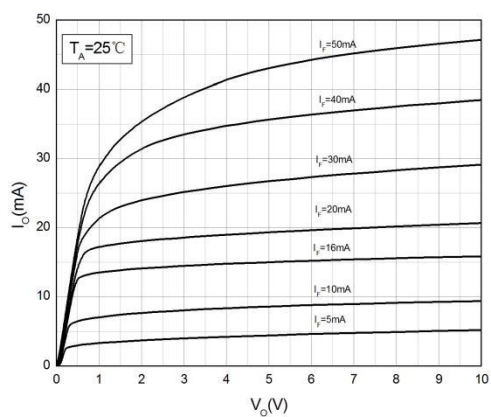
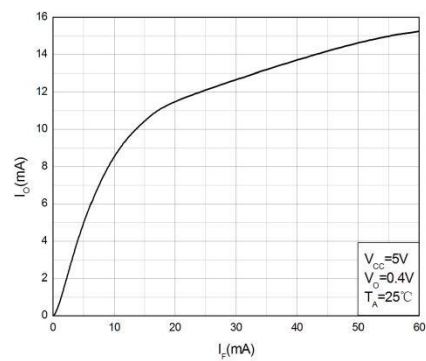


Fig.6 Output Current vs. Forward Current



CHARACTERISTIC CURVES

Fig.7 Logic High Output Current vs. Ambient Temperature

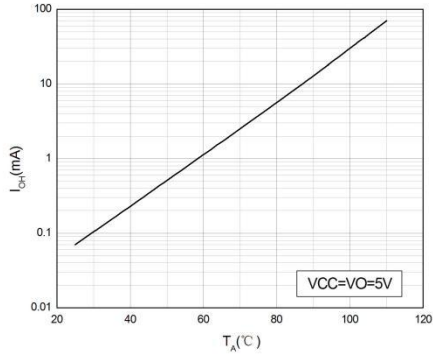


Fig.8 Propagation Delay vs. Load Resistance

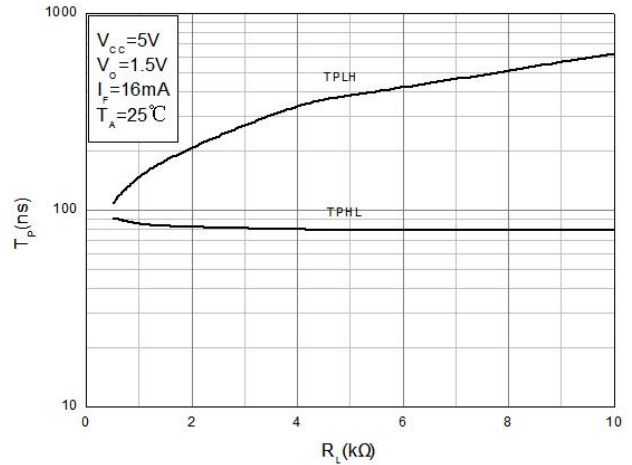


Fig.9 Switching Time vs. Load Resistance

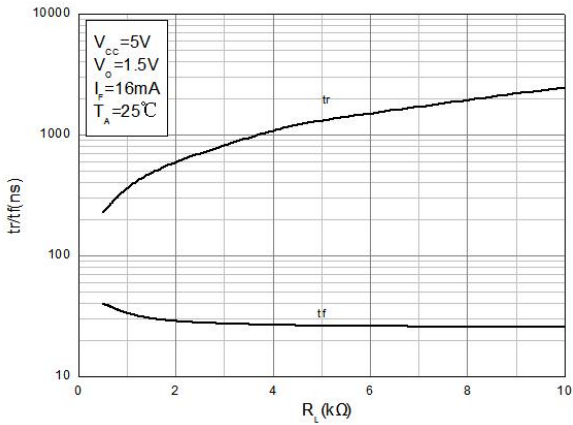


Fig.10 Propagation Delay vs. Ambient Temperature

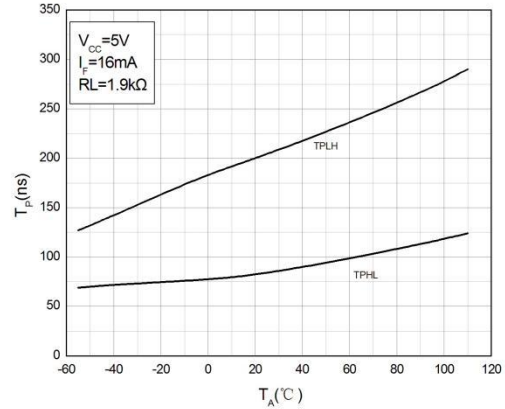
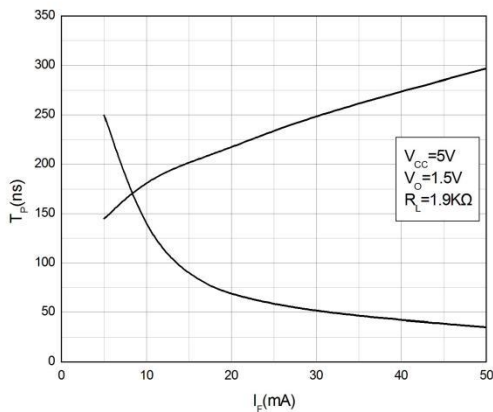


Fig.11 Propagation Delay vs. Forward Current



TEST CIRCUITS

Fig.13 Test Circuits for TPHL, TPLH, tr, tf

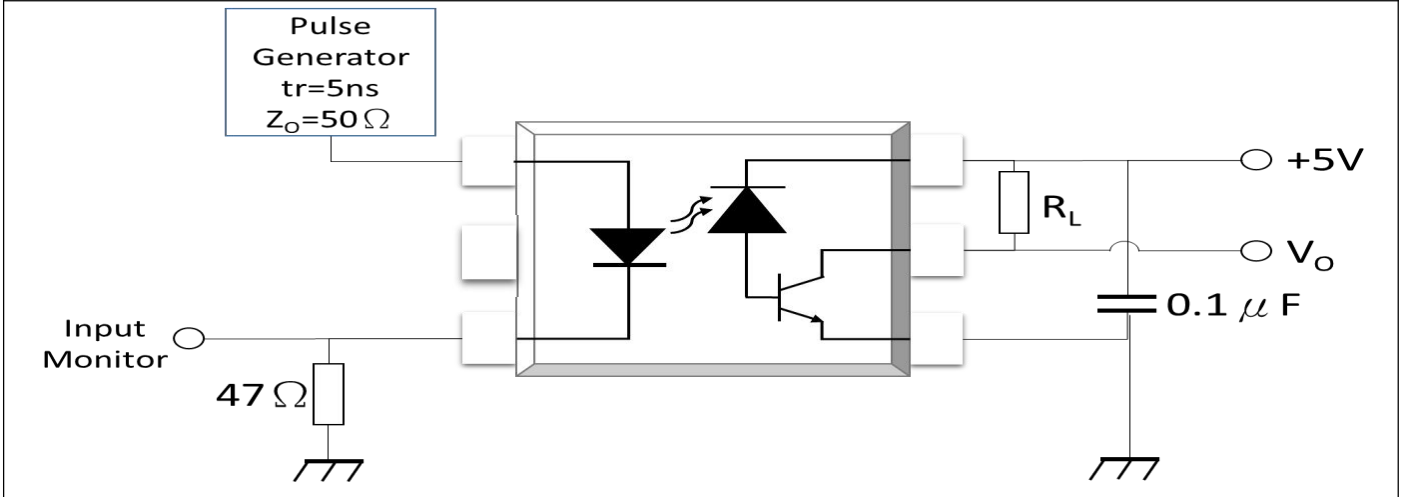
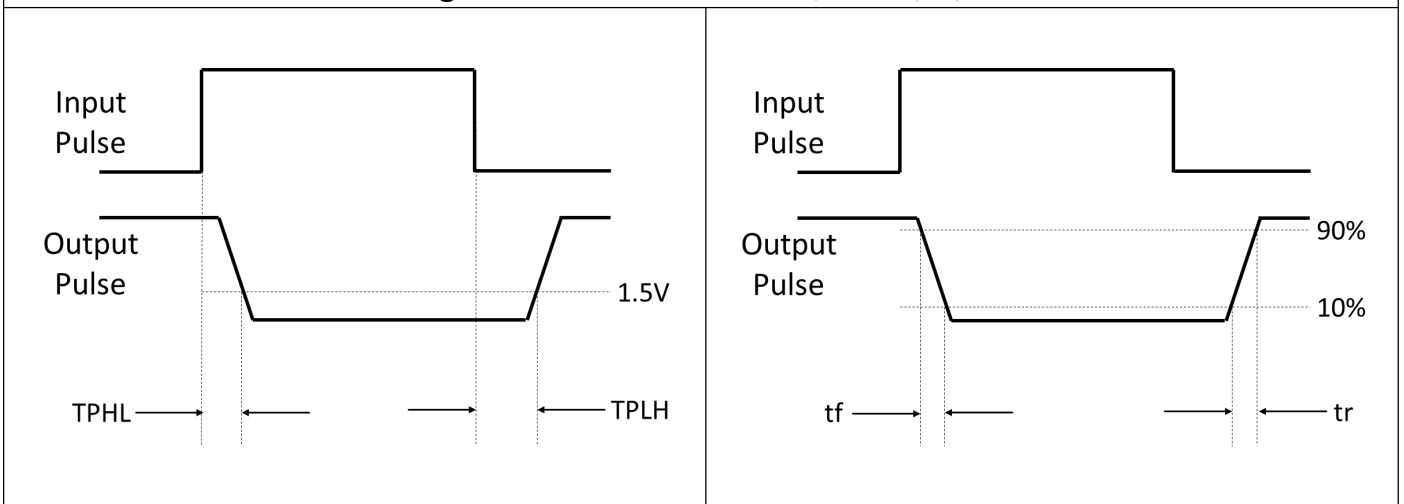


Fig.14 Waveforms of TPHL, TPLH, tr, tf



TEST CIRCUITS

Fig.15 Test Circuits for Common Mode Transient Immunity

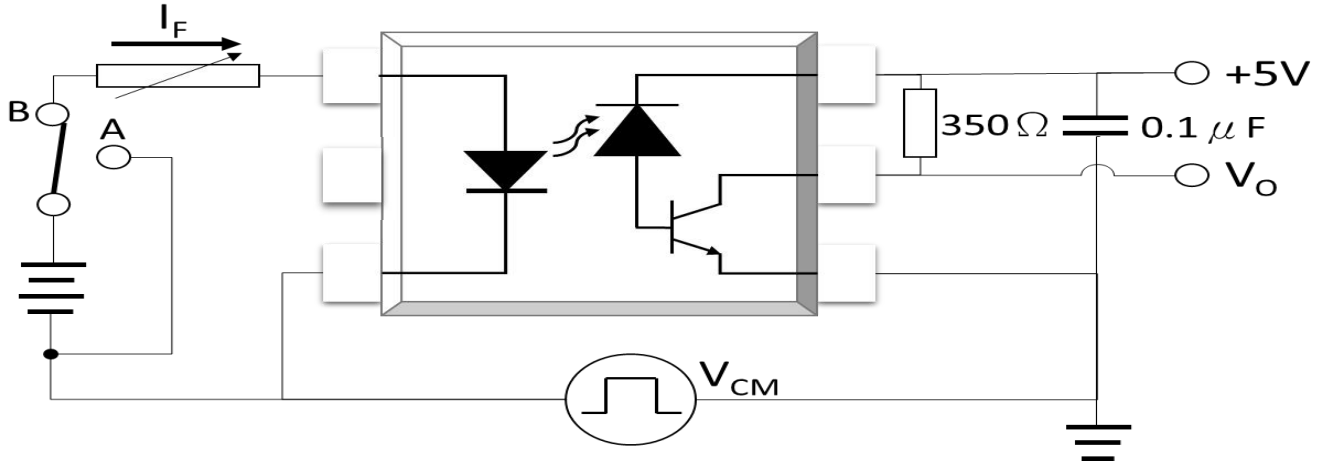
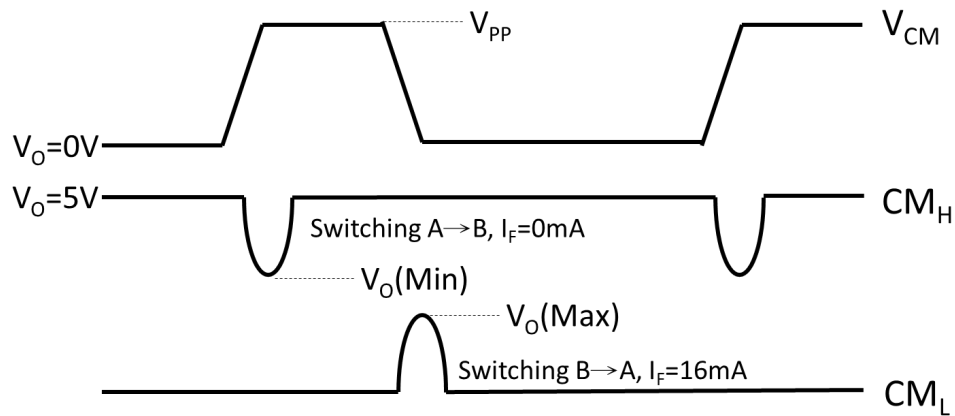
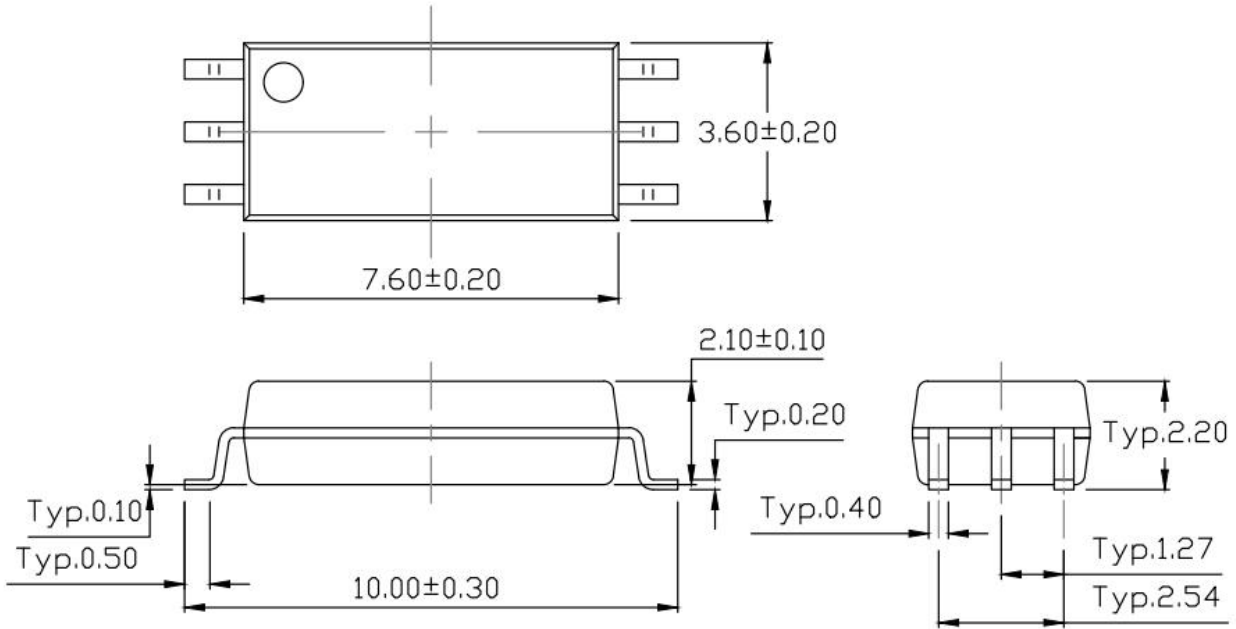


Fig.16 Wave forms of Common Mode Transient Immunity

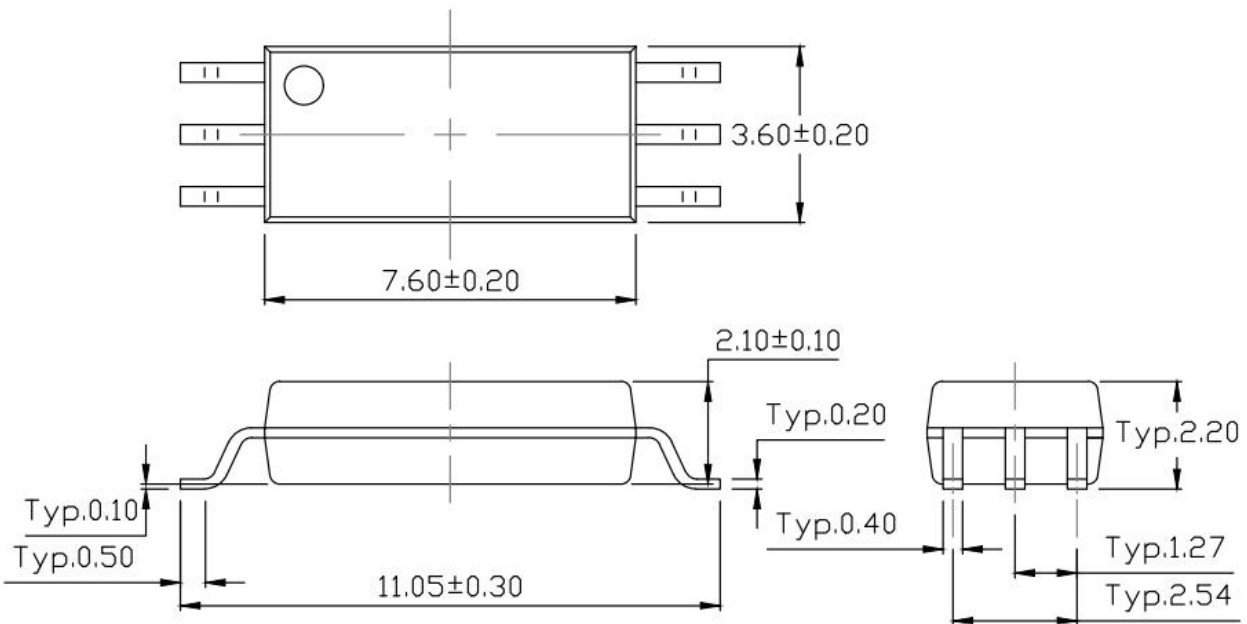


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard P Type

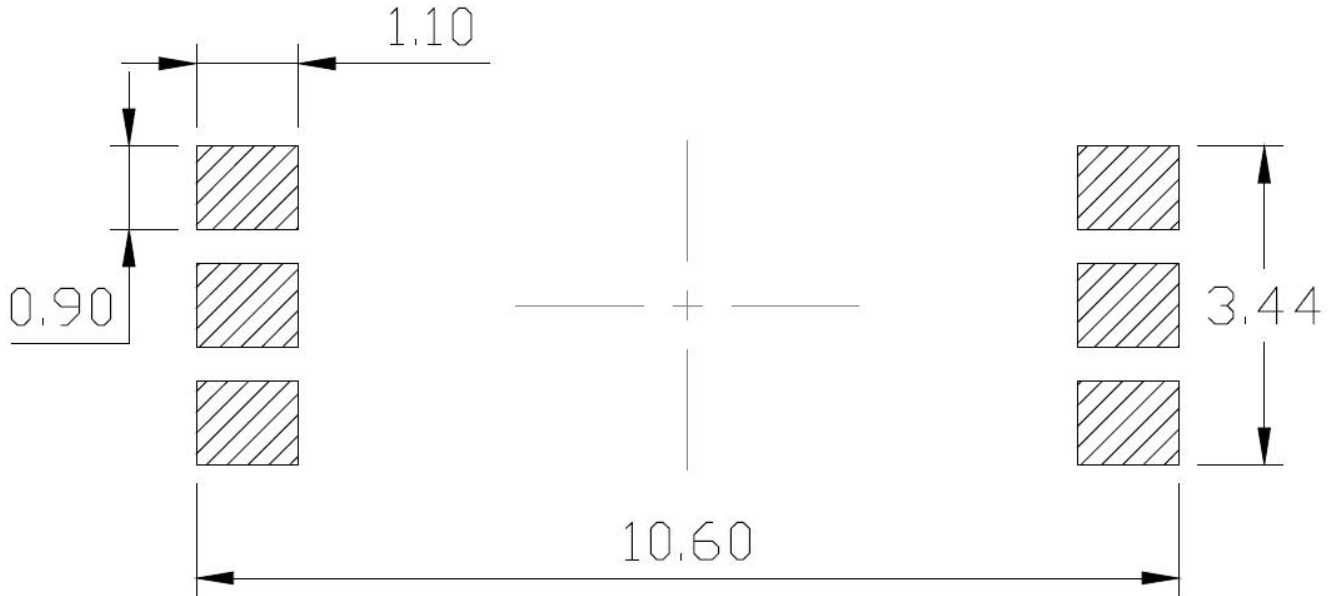


Standard W Type

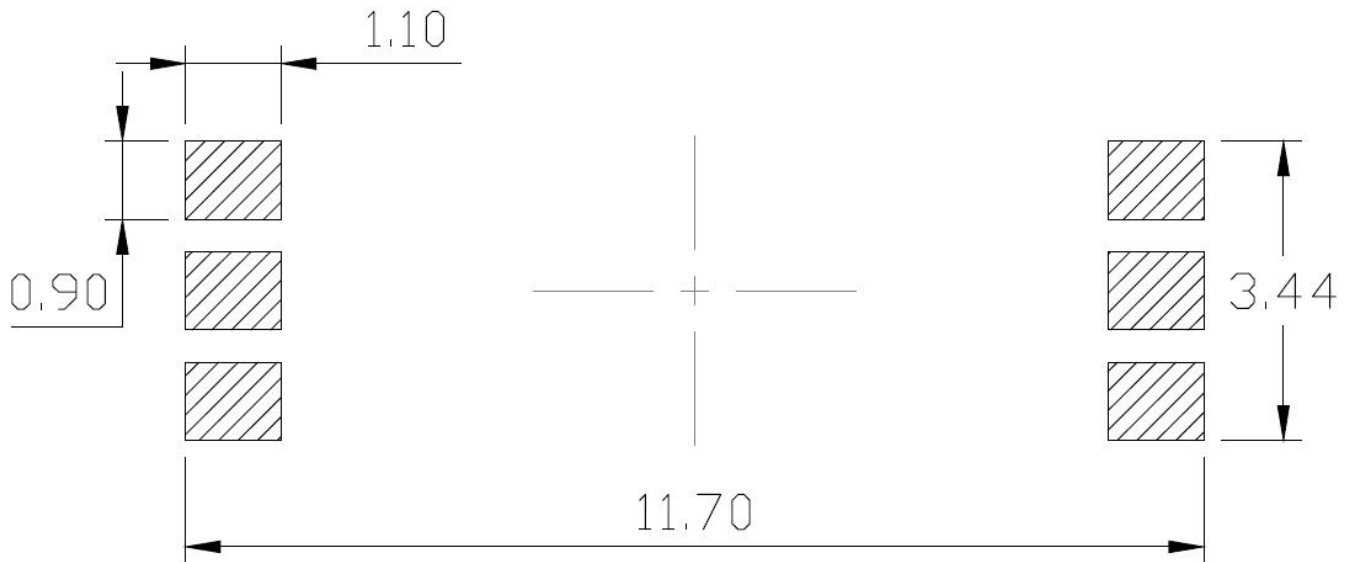


Recommended Solder Mask (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

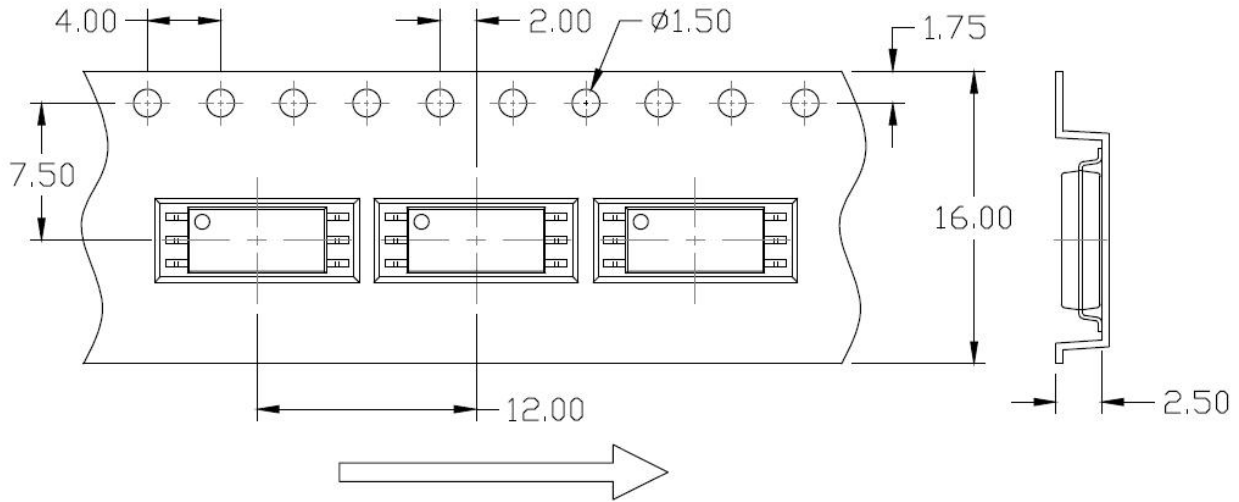


Surface Mount (Gullwing) Lead Forming

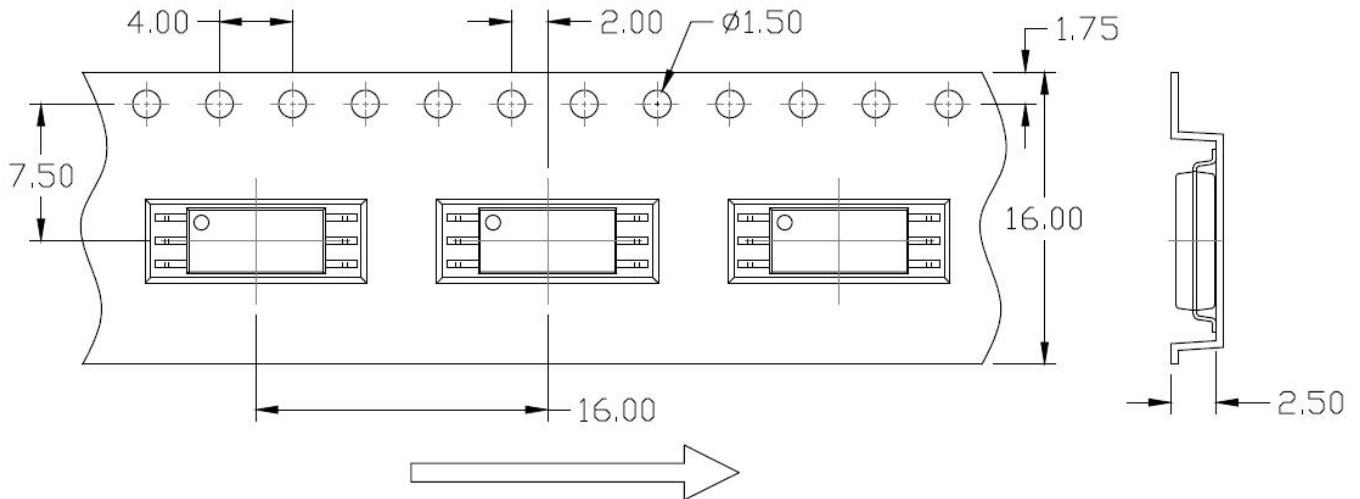


CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Standard P Type

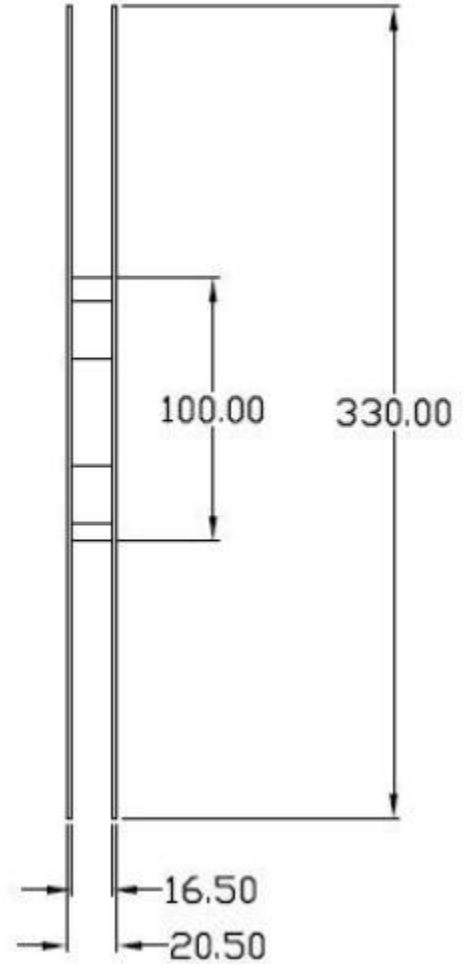


Standard W Type



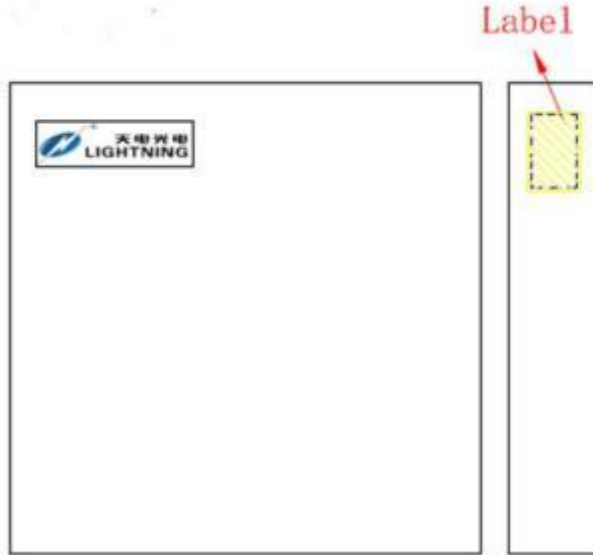
REEL SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option



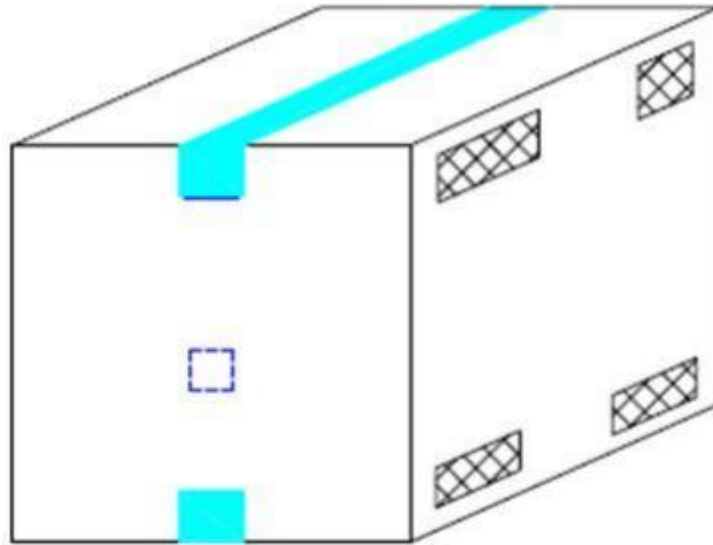
BOX SPECIFICATIONS (Reel Type)

Inner Box



- L x W x H = 36cm x 36cm x 6.9cm

Outer Box

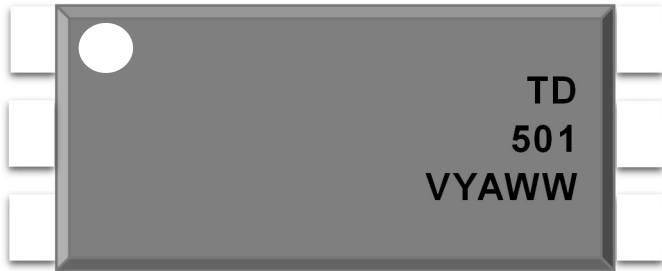


- L x W x H = 45cm x 3



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.
501 : Part Number
V : VDE Option
Y : Fiscal Year
A : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

TDL501(Y)(Z)-GV

TD – Company Abbr
 L – LSOP6
 501 – Part Number
 Y – Lead Form Option (P/W)
 Z – Tape and Reel Option (T3)
 G – Material Option
 (G: Green, None: Non-Green)
 V – VDE Option (V or None)

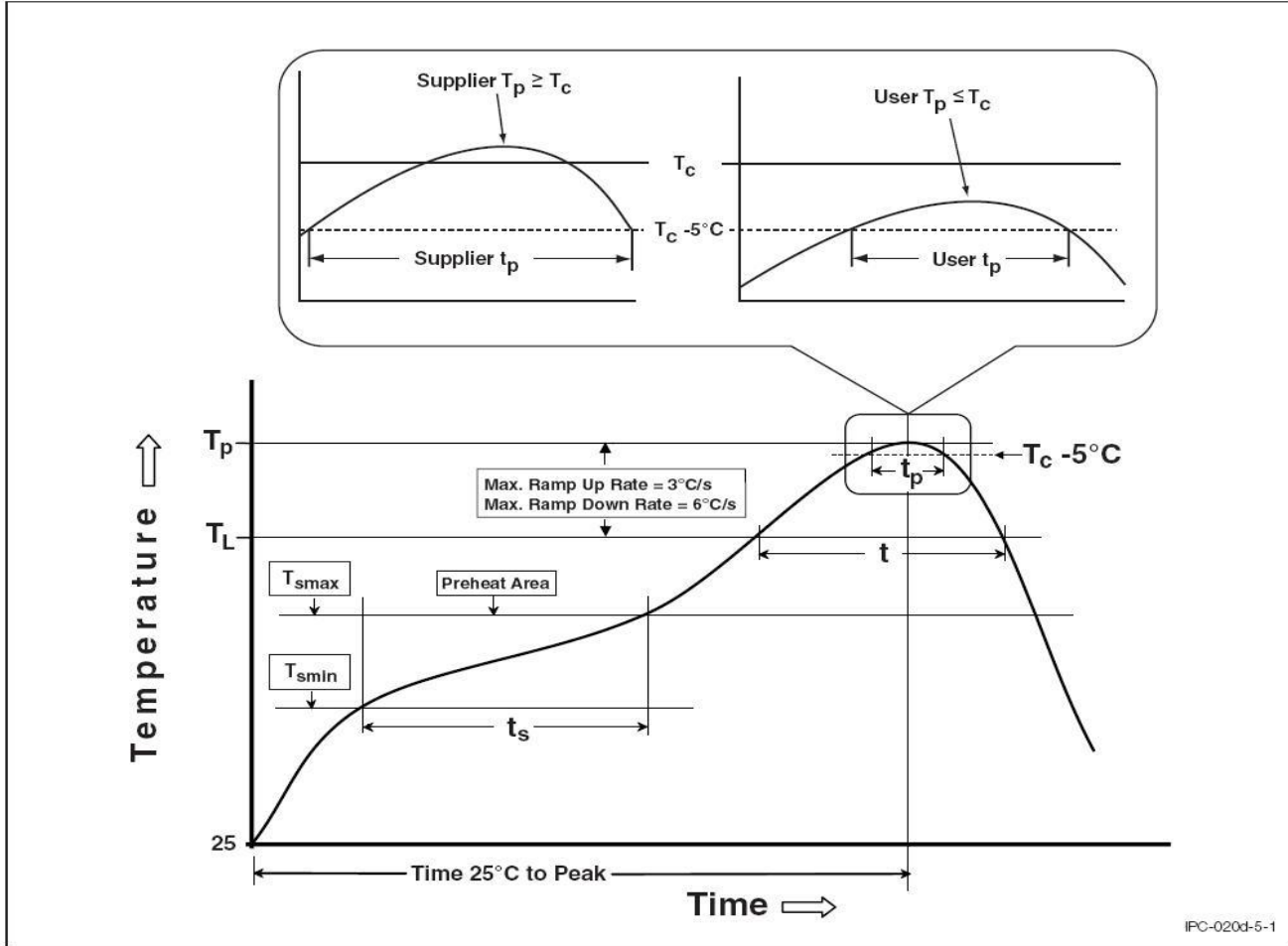


PACKING QUANTITY

| Option | Quantity | Quantity – Inner box | Quantity – Outer box |
|--------|-----------------|----------------------|-------------------------------------|
| T3 | 1500 Units/Reel | 3 Reels/Inner box | 5 Inner box/Outer box = 22.5k Units |
| | | | |

REFLOW INFORMATION

REFLOW PROFILE



| Profile Feature | Sn-Pb Assembly Profile | Pb-Free Assembly Profile |
|--|------------------------|--------------------------|
| Temperature Min. (T_{smin}) | 100 | 150°C |
| Temperature Max. (T_{smax}) | 150 | 200°C |
| Time (t_s) from (T_{smin} to T_{smax}) | 60-120 seconds | 60-120 seconds |
| Ramp-up Rate (t_L to t_P) | 3°C/second max. | 3°C/second max. |
| Liquidous Temperature (T_L) | 183°C | 217°C |
| Time (t_L) Maintained Above (T_L) | 60 – 150 seconds | 60 – 150 seconds |
| Peak Body Package Temperature | 235°C +0°C / -5°C | 260°C +0°C / -5°C |
| Time (t_P) within 5°C of 260°C | 20 seconds | 30 seconds |
| Ramp-down Rate (T_P to T_L) | 6°C/second max | 6°C/second max |
| Time 25°C to Peak Temperature | 6 minutes max. | 8 minutes max. |



DISCLAIMER

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- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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- This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or lifesaving applications or any other application which can result in human injury or death.
- Please contact LIGHTNING sales agent for special application request.
- Immerge unit's body in solder paste is not recommended.
- Parameters provided in datasheets may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated in each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify LIGHTNING's terms and conditions of purchase, including but not limited to the warranty expressed therein.
- Discoloration might be occurred on the package surface after soldering, reflow or long-time use. It neither impacts the performance nor reliability.